

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
-20V	40m $\Omega$ @-4.5V	-5A
	70m $\Omega$ @-2.5V	

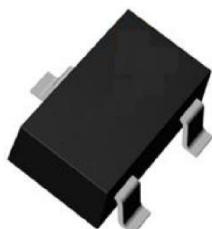
## Feature

- Split gate trench MOSFET technology
- Extremely low switching loss
- Excellent stability and uniformity
- Epoxy Meets UL 94 V-0 Flammability Rating
- Suffix "-Q1" for AEC-Q101

## Application

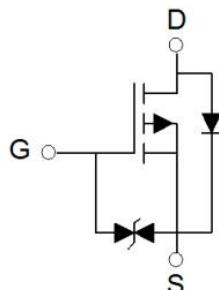
- power management
- Portable equipment

## Package

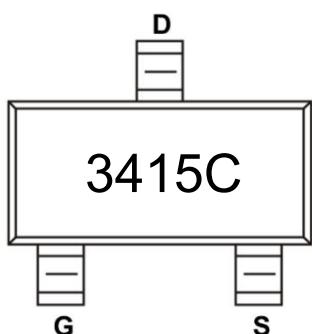


SOT-23

## Circuit diagram



## Marking



**Absolute maximum ratings (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Continuous Drain Current	I <sub>D</sub>	-5	A
Continuous Drain Current(T <sub>A</sub> =100°C)	I <sub>D</sub>	-3.2	A
Pulsed Drain Current <sup>1)</sup>	I <sub>DM</sub>	-30	A
Power Dissipation <sup>2)</sup>	P <sub>D</sub>	1	W
Thermal Resistance Junction to Ambient <sup>3)</sup>	R <sub>θJA</sub>	120	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

**Electrical characteristics (T<sub>J</sub>=25 °C unless otherwise noted)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V			±10	μA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.55	-0.85	-1.25	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A		28	40	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -4A		50	70	
<b>Dynamic characteristics<sup>4)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1MHz		540		pF
Output Capacitance	C <sub>oss</sub>			120		
Reverse Transfer Capacitance	C <sub>rss</sub>			100		
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -5A		13		nC
Gate-Source Charge	Q <sub>gs</sub>			2		
Gate-Drain Charge	Q <sub>gd</sub>			2		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> = -10V, V <sub>DD</sub> = -10V I <sub>D</sub> = -5A, R <sub>GEN</sub> = 2.2Ω		5		nS
Turn-on rise time	t <sub>r</sub>			47		
Turn-off delay time	t <sub>d(off)</sub>			52		
Turn-off fall time	t <sub>f</sub>			69		
<b>Source-Drain Diode characteristics</b>						
Diode Forward Current	I <sub>S</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -5A			-5	V
Diode Forward voltage	V <sub>SD</sub>				-1.2	V

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2) P<sub>d</sub> is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.
- 3) The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in the still air environment with T<sub>A</sub> = 25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- 4) Guaranteed by design, not subject to production testing.



## Typical Characteristics

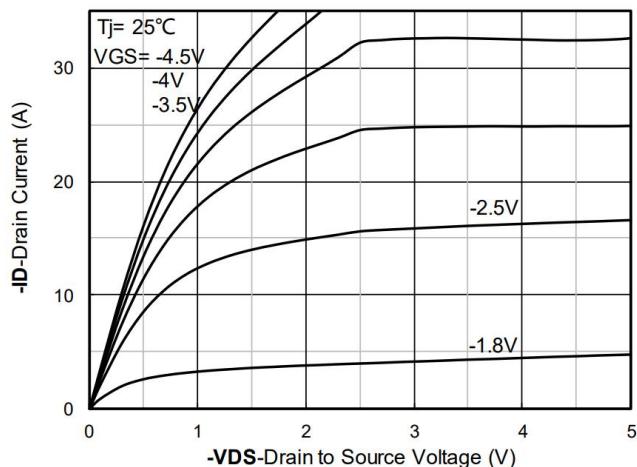


Figure 1. Output Characteristics

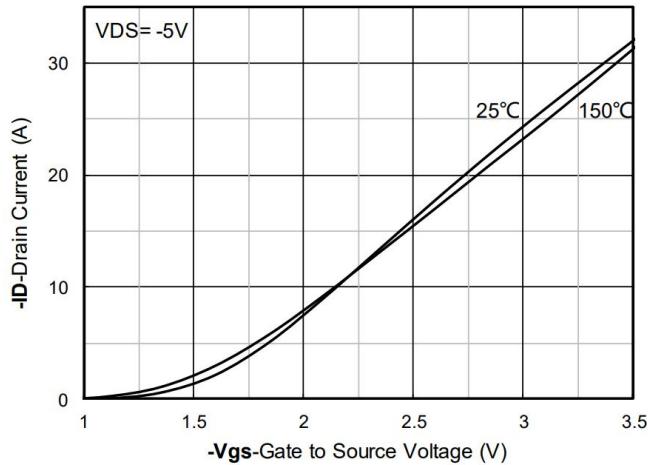


Figure 2. Transfer Characteristics

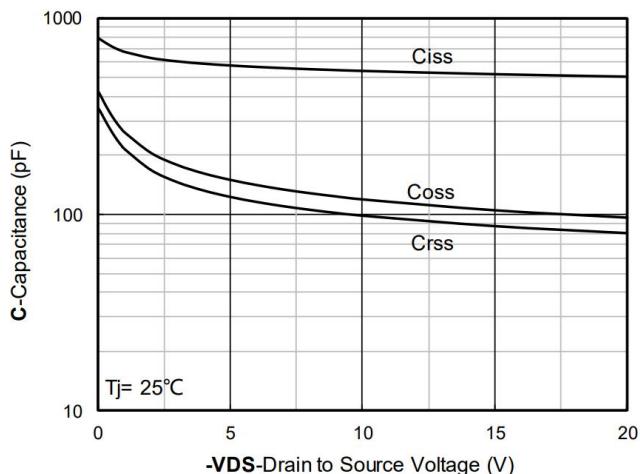


Figure 3. Capacitance Characteristics

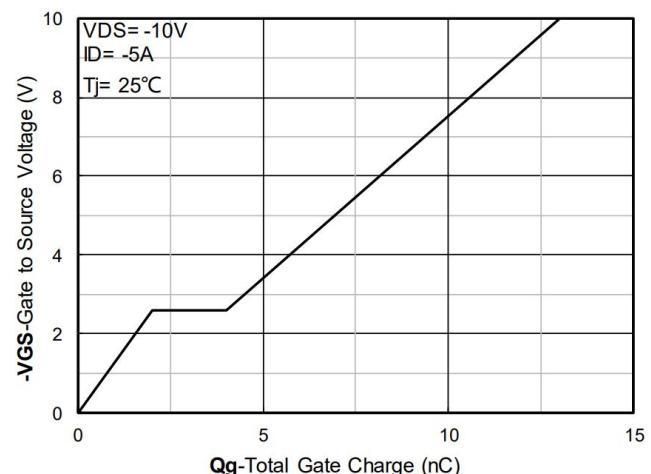


Figure 4. Gate Charge

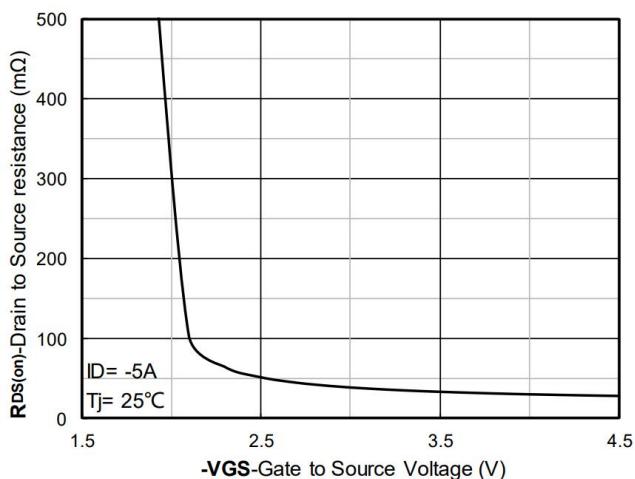


Figure 5. On-Resistance vs Gate to Source Voltage

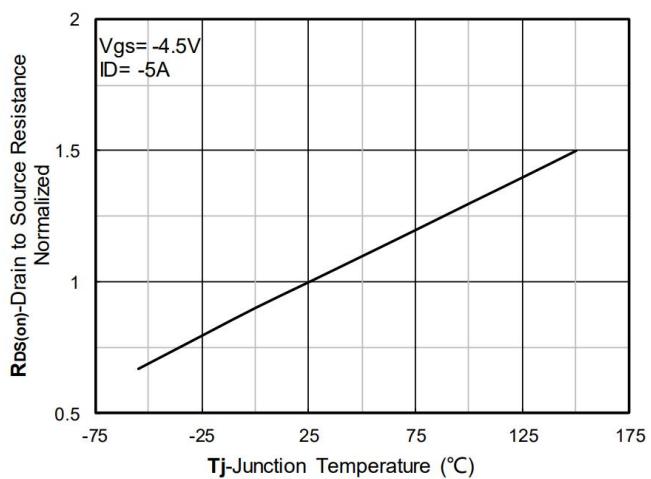


Figure 6. Normalized On-Resistance

## Typical Characteristics

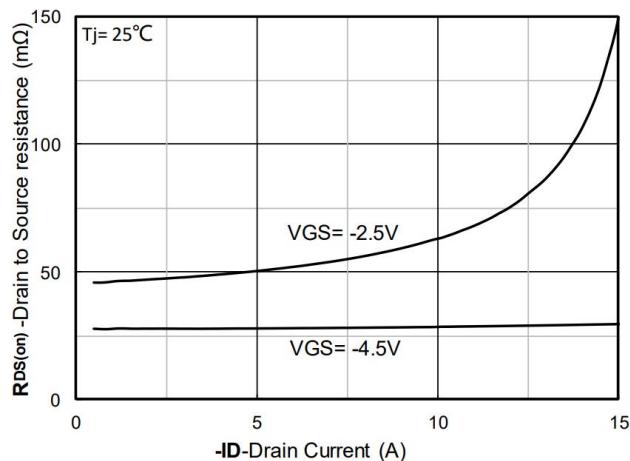


Figure 7. RDS(on) VS Drain Current

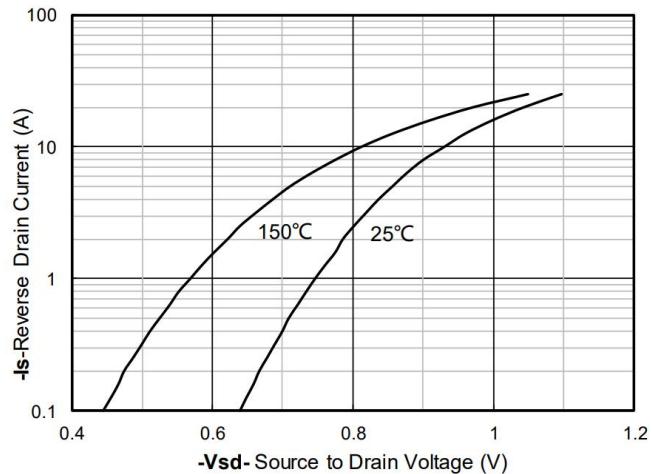


Figure 8. Forward characteristics of reverse diode

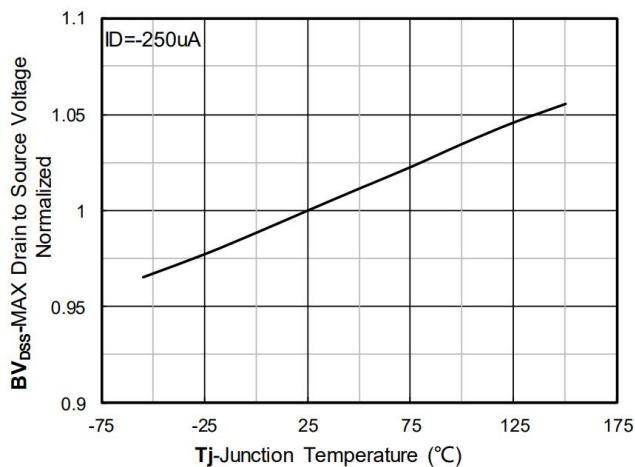


Figure 9. Normalized breakdown voltage

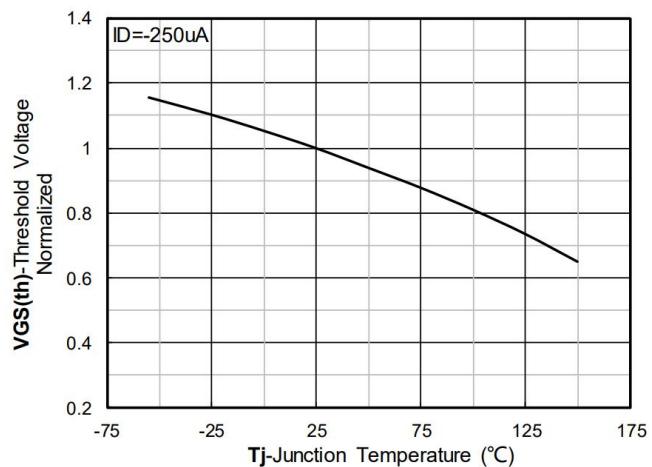


Figure 10. Normalized Threshold voltage

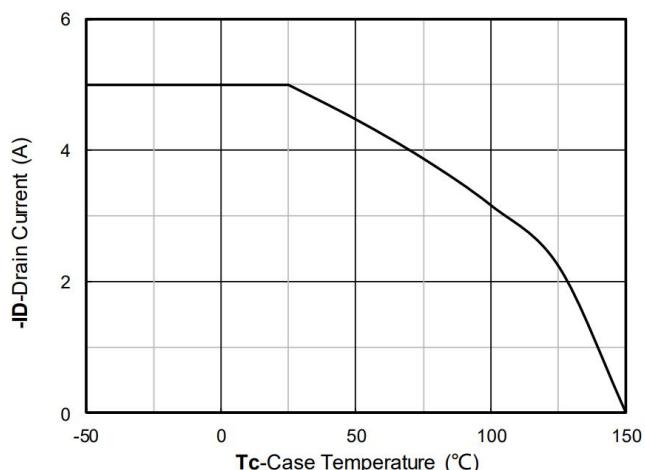


Figure 11. Current dissipation

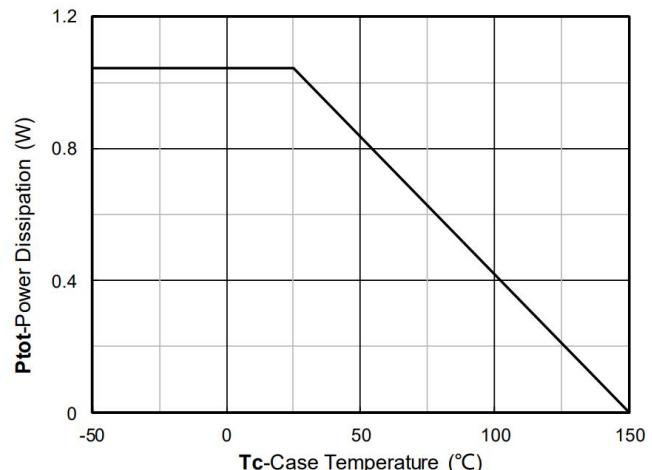
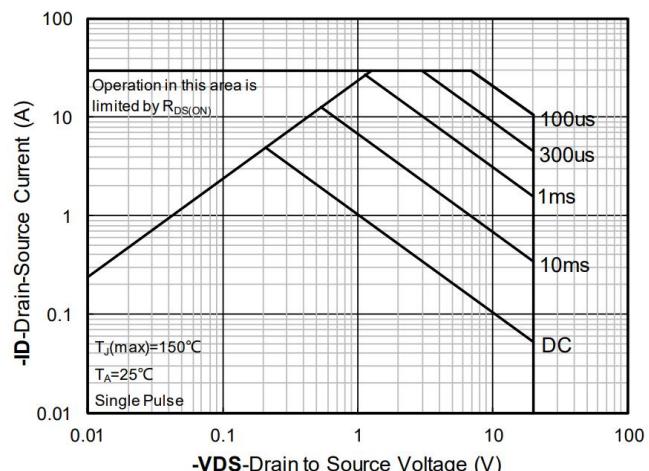
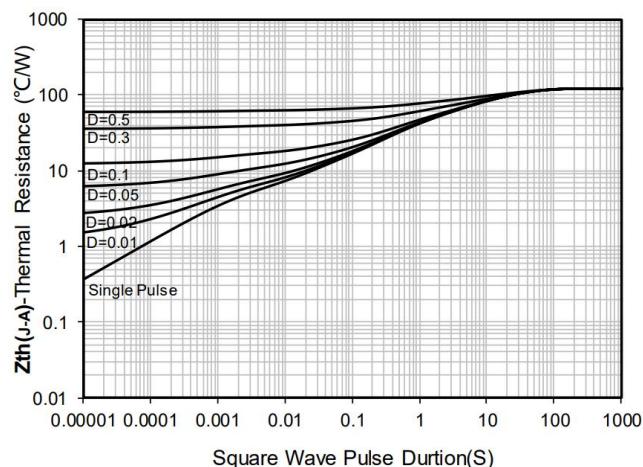
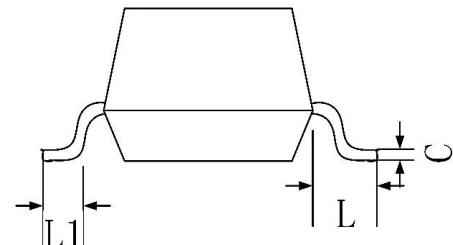
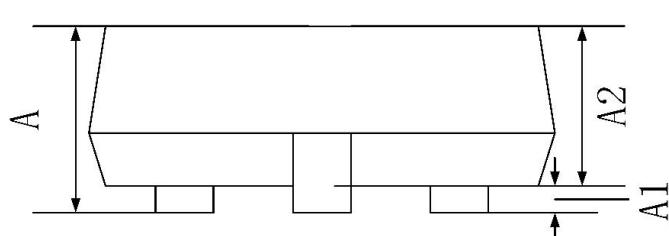
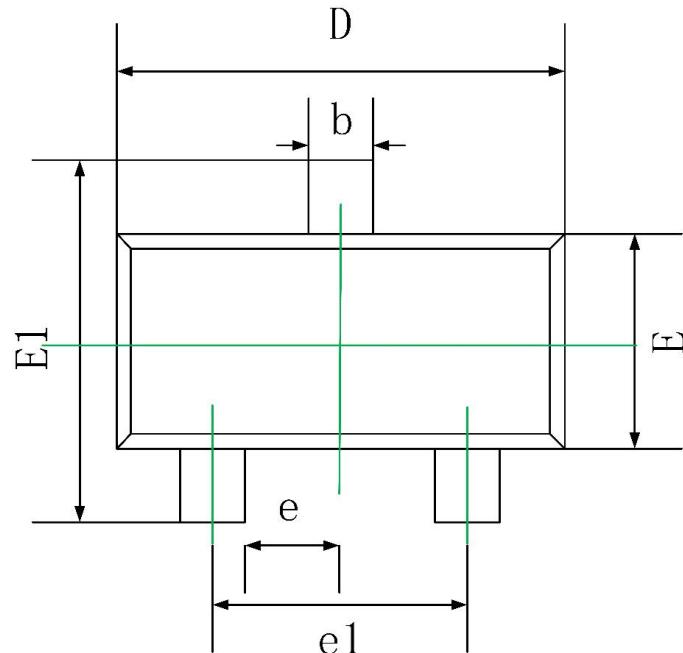


Figure 12. Power dissipation

## Typical Characteristics



**SOT-23 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.200	0.003	0.008
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020